

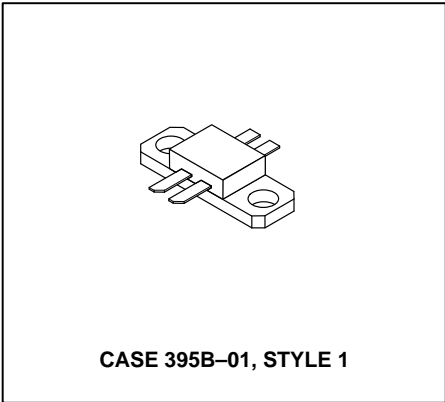
The RF Line

NPN Silicon

RF Power Transistor

Designed for 24 Volt UHF large-signal, common emitter, class-AB linear amplifier applications in industrial and commercial FM/AM equipment operating in the range 800-970 MHz.

- Specified 24 Volt, 900 MHz Characteristics
 - Output Power = 30 Watts
 - Minimum Gain = 10 dB @ 900 MHz, class-AB
 - Minimum Efficiency = 30% @ 900 MHz, 30 Watts (PEP)
 - Maximum Intermodulation Distortion -30 dBc @ 30 Watts (PEP)
- Characterized with Series Equivalent Large-Signal Parameters from 800 to 960 MHz
- Silicon Nitride Passivated
- 100% Tested for Load Mismatch Stress at all Phase Angles with 5:1 VSWR @ 26 Vdc, and Rated Output Power
- Gold Metalized, Emitter Ballasted for Long Life and Resistance to Metal-Migration
- Circuit board photomaster available upon request by contacting RF Tactical Marketing in Phoenix, AZ.



MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CEO}	30	Vdc
Collector-Emitter Voltage	V _{CES}	60	Vdc
Emitter-Base Voltage	V _{EBO}	4.0	Vdc
Collector-Current — Continuous	I _C	4.0	Adc
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	105 0.60	Watts W/°C
Storage Temperature Range	T _{stg}	-65 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	R _{θJC}	1.67	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage (I _C = 50 mAdc, I _B = 0)	V _{(BR)CEO}	30	33	—	Vdc
Collector-Emitter Breakdown Voltage (I _C = 50 mAdc, V _{BE} = 0)	V _{(BR)CES}	60	80	—	Vdc
Emitter-Base Breakdown Voltage (I _E = 5 mAdc, I _C = 0)	V _{(BR)EBO}	4.0	4.7	—	Vdc
Collector Cutoff Current (V _{CE} = 30 Vdc, V _{BE} = 0)	I _{CES}	—	—	10.0	mAdc

ON CHARACTERISTICS

DC Current Gain (I _{CE} = 1.0 Adc, V _{CE} = 5 Vdc)	h _{FE}	30	80	120	—
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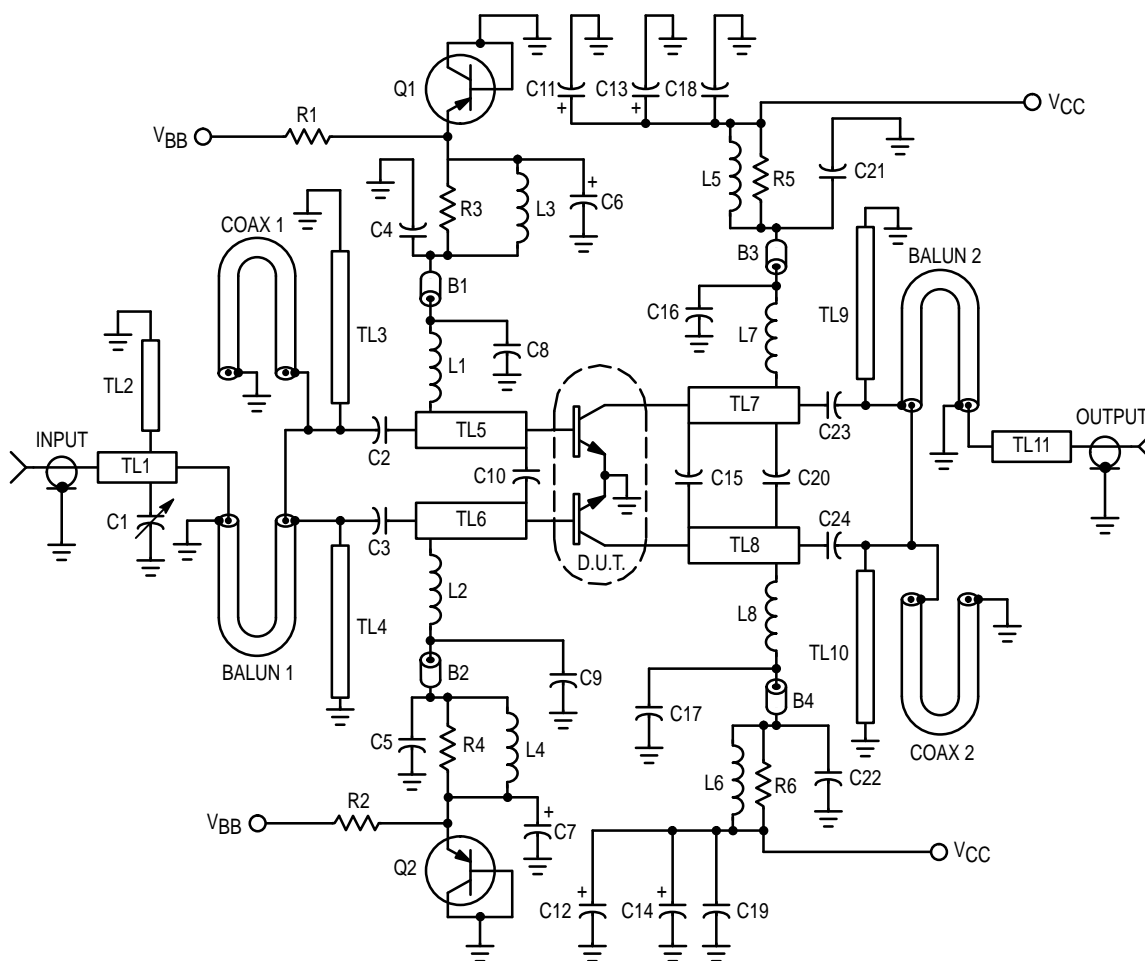
DYNAMIC CHARACTERISTICS

Output Capacitance (V _{CB} = 24 Vdc, I _E = 0, f = 1.0 MHz)	C _{ob}	14	21	28	pF
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(continued)

ELECTRICAL CHARACTERISTICS — continued ($T_C = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
FUNCTIONAL CHARACTERISTICS					
Common-Emitter Amplifier Power Gain ($V_{CC} = 24\text{ Vdc}$, $P_{\text{out}} = 30\text{ Watts (PEP)}$, $I_{CQ} = 125\text{ mA}$, $f_1 = 900\text{ MHz}$, $f_2 = 900.1\text{ MHz}$)	G_{pe}	10.0	12.0	—	dB
Collector Efficiency ($V_{CC} = 24\text{ Vdc}$, $P_{\text{out}} = 30\text{ Watts (PEP)}$, $I_{CQ} = 125\text{ mA}$, $f_1 = 900\text{ MHz}$, $f_2 = 900.1\text{ MHz}$)	η	35	38	—	%
Intermodulation Distortion ($V_{CC} = 24\text{ Vdc}$, $P_{\text{out}} = 30\text{ Watts (PEP)}$, $I_{CQ} = 125\text{ mA}$, $f_1 = 900\text{ MHz}$, $f_2 = 900.1\text{ MHz}$)	IMD	—	-37	-30	dBc
Output Mismatch Stress ($V_{CC} = 26\text{ Vdc}$, $P_{\text{out}} = 30\text{ Watts (PEP)}$, $I_{CQ} = 125\text{ mA}$, $f_1 = 900\text{ MHz}$, $f_2 = 900.1\text{ MHz}$, Load VSWR = 5:1 (all phase angles))	ψ	No Degradation in Output Power Before and After Test			



- B1, B2, B3, B4 — Ferrite Bead, Fair Rite #2743019447
- C1 — 0.8–8.0 pF Trimmer Capacitor, Johanson
- C2, C3, C23, C24 — 43 pF, 100 mil, ATC Chip Capacitor
- C4, C5, C18, C19, C21, C22 — 820 pF, 100 mil, Chip Capacitor, Kemet
- C6, C7, C11, C12 — 10 μF , Lytic Capacitor, Panasonic
- C8, C9, C16, C17 — 100 pF, 100 mil, Chip Capacitor, Murata Erie
- C10 — 13 pF, 50 mil, ATC Chip Capacitor
- C13, C14 — 250 μF Lytic Capacitor, Mallory
- C15 — 1.1 pF, 50 mil, ATC Chip Capacitor
- C20 — 6.8 pF, 100 mil, ATC Chip Capacitor
- L1, L2, L3, L4, L5, L6 — 5 Turns 20 AWG, IDIA 0.126" choke

- N1, N2 — Type N Flange Mount, Omni Spectra 3052–1648–10
- Q1 — Bias Transistor BD136 PNP
- R1, R12 — 39 Ohm, 2.0 W
- R3, R4, R5, R6 — 4.0 x 39 Ohm, 1/8 W, Chips in Parallel, Rohm 390–J
- TL1–TL11 — See Photomaster
- Balun1, Balun2, Coax 1, Coax 2 — 2.20" 50 Ohm, 0.088" o.d. semi-rigid coax, Micro Coax UT–85–M17
- Board — 1/32" Glass Teflon, Arlon GX–0300–55–22, $\epsilon_r = 2.55$

Figure 1. MRF897 Broadband Test Circuit

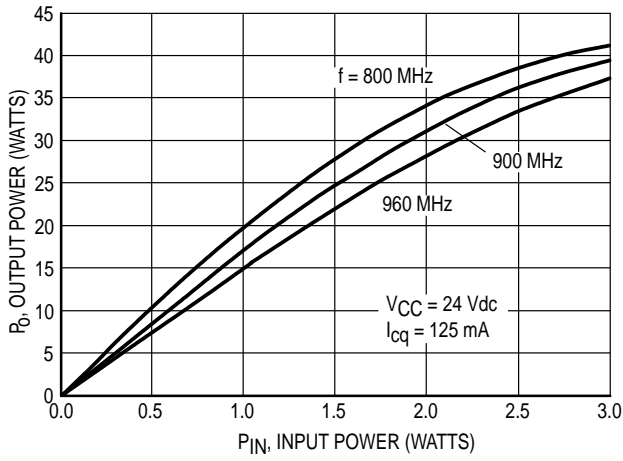


Figure 2. Output Power versus Input Power

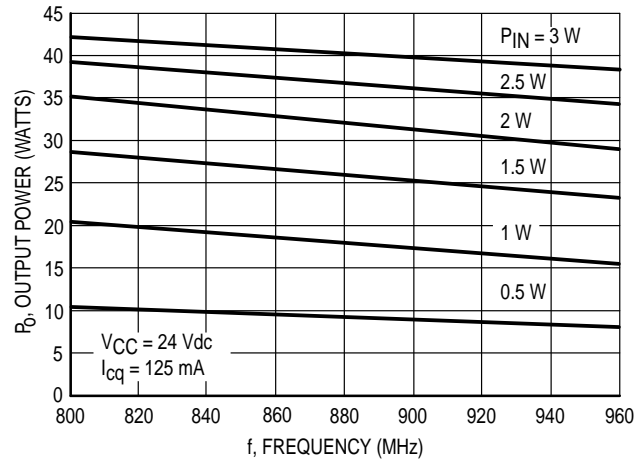


Figure 3. Output Power versus Frequency

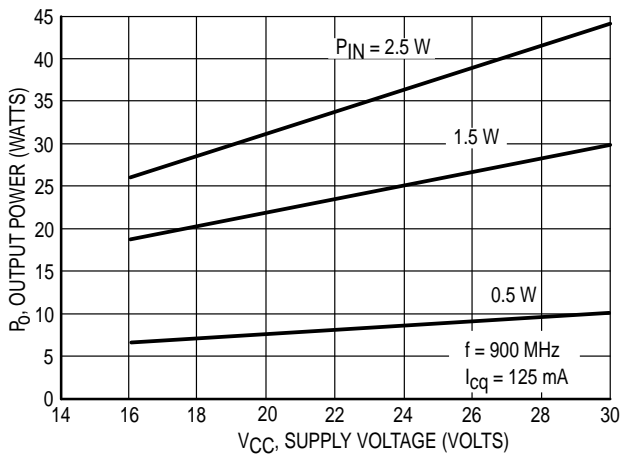


Figure 4. Output Power versus Supply Voltage

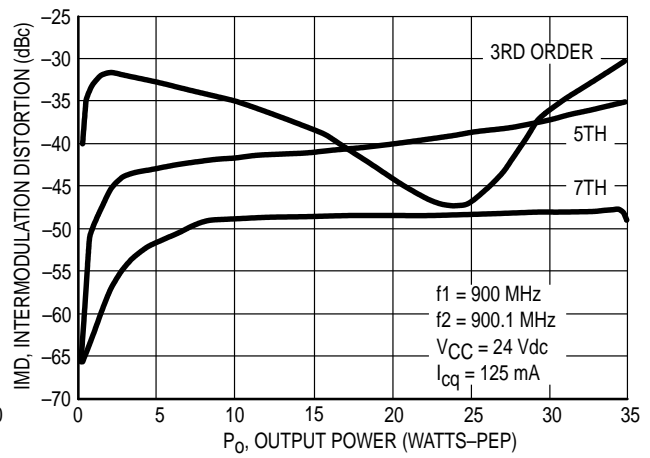


Figure 5. Intermodulation versus Output Power

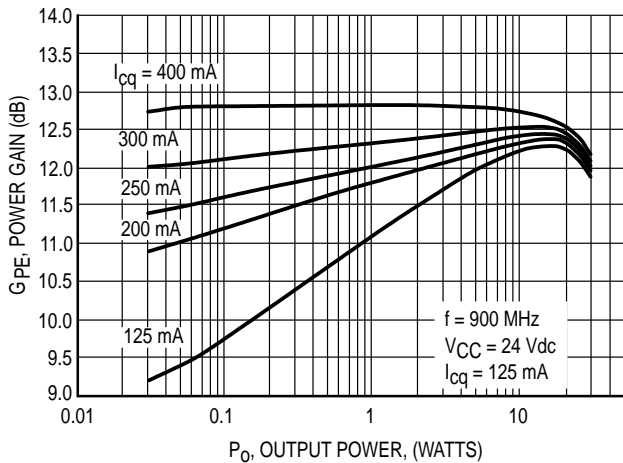


Figure 6. Power Gain versus Output Power

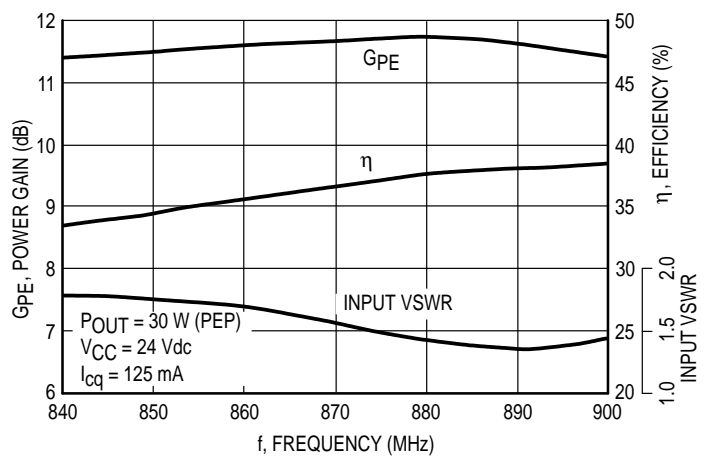
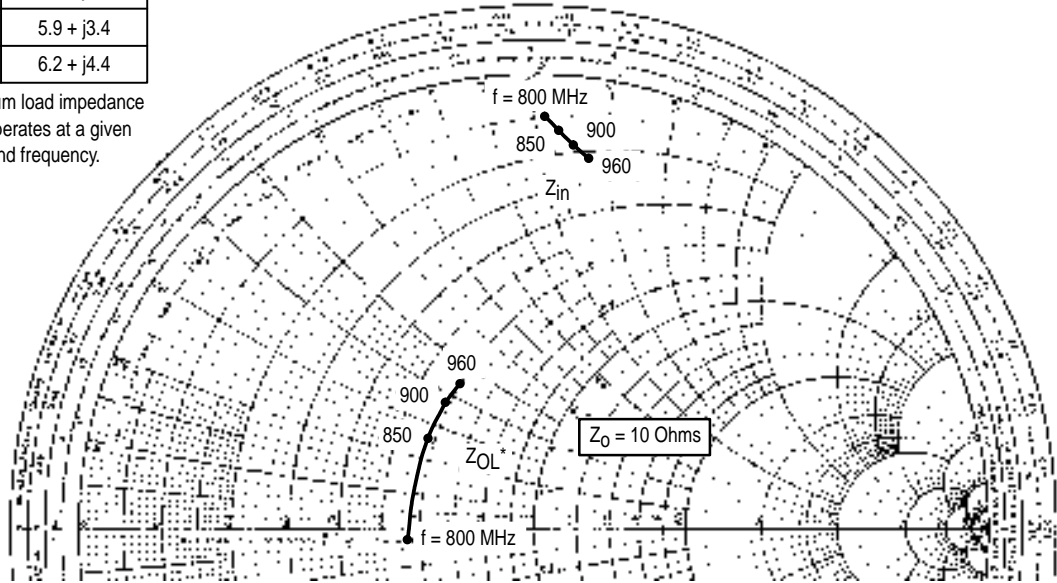


Figure 7. Broadband Test Fixture Performance

f MHz	Z _{in} Ohms	Z _{OL} * Ohms
800	1.0 + j10.3	5.9 - j0.4
850	1.5 + j10.5	5.7 + j2.6
900	1.8 + j11.0	5.9 + j3.4
960	2.2 + j11.4	6.2 + j4.4

Z_{OL}* = Conjugate of the optimum load impedance into which the device operates at a given output power, voltage and frequency.

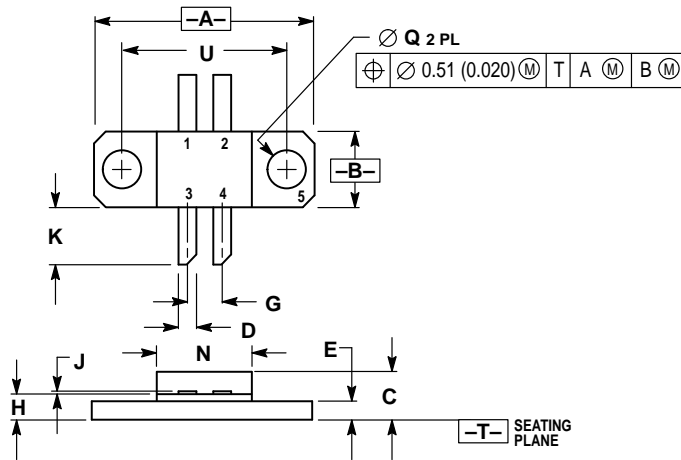


NOTE: Z_{in} & Z_{OL}* are given from base-to-base and collector-to-collector respectively.

P_o = 300 W (PEP), V_{CC} = 24 V

Figure 8. Series Equivalent Input/Output Impedances

PACKAGE DIMENSIONS




- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.739	0.750	18.77	19.05
B	0.240	0.260	6.10	6.60
C	0.165	0.198	4.19	5.03
D	0.055	0.065	1.40	1.65
E	0.055	0.070	1.40	1.78
G	0.110	0.130	2.79	3.30
H	0.079	0.091	2.01	2.31
J	0.003	0.005	0.08	0.13
K	0.180	0.220	4.57	5.59
N	0.315	0.330	8.00	8.38
Q	0.125	0.135	3.18	3.42
U	0.560 BSC		14.22 BSC	

- STYLE 1:
 PIN 1. BASE
 2. BASE
 3. COLLECTOR
 4. COLLECTOR
 5. EMITTER

**CASE 395B-01
 ISSUE A**

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MRF897/D

